

## Features

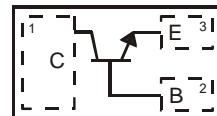
- Complementary PNP Type Available (MMBT3906LP)
- Ultra-Small Leadless Surface Mount Package
- **Lead, Halogen, and Antimony Free, RoHS Compliant (Note 1)**
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

## Mechanical Data

- Case: DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: Collector Dot
- Terminals: Finish — NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.0008 grams (approximate)



Bottom View



Top View  
Device Schematic

## Ordering Information (Note 3)

Part Number	Case	Packaging
MMBT3904LP-7	DFN1006-3	3000/Tape & Reel

Notes:

1. No purposefully added lead. Halogen and Antimony free.
2. Diodes Inc's "Green" policy can be found on our website at [http://www.diodes.com/products/lead\\_free/index.php](http://www.diodes.com/products/lead_free/index.php).
3. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

## Marking Information



1N = Product Type Marking Code  
Dot Denotes Collector Side

**Maximum Ratings** @ $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	60	V
Collector-Emitter Voltage	$V_{CEO}$	40	V
Emitter-Base Voltage	$V_{EBO}$	6.0	V
Collector Current - Continuous (Note 4)	$I_C$	200	mA

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	$P_D$	250	mW
Thermal Resistance, Junction to Ambient (Note 4)	$R_{\theta JA}$	500	°C/W
Operating and Storage and Temperature Range	$T_J, T_{STG}$	-55 to +150	°C

Notes: 4. Device mounted on FR-4 PCB pad layout as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

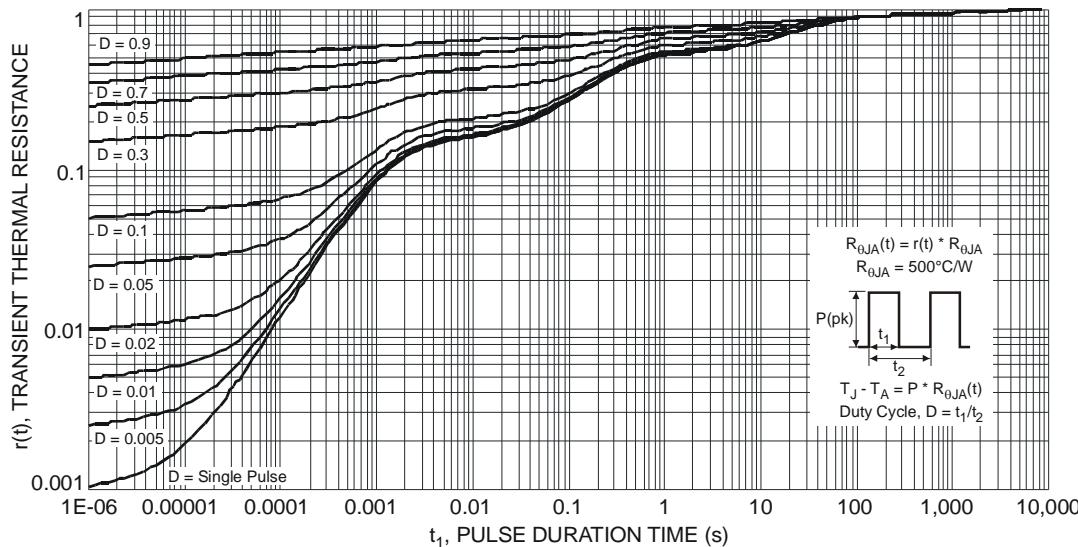


Fig. 1 Transient Thermal Response

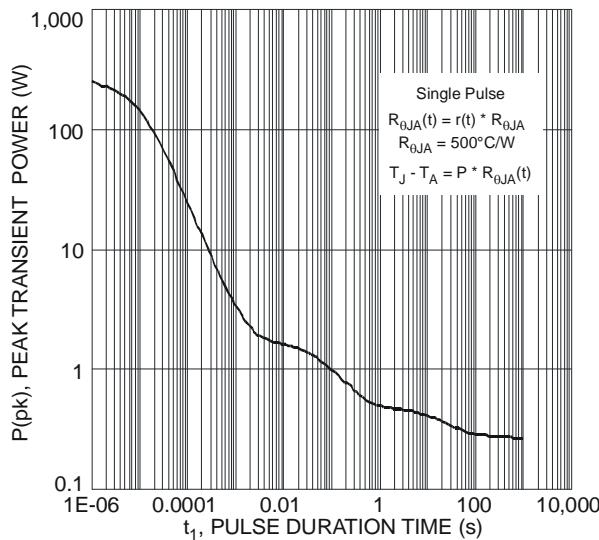


Fig. 2 Single Pulse Maximum Power Dissipation

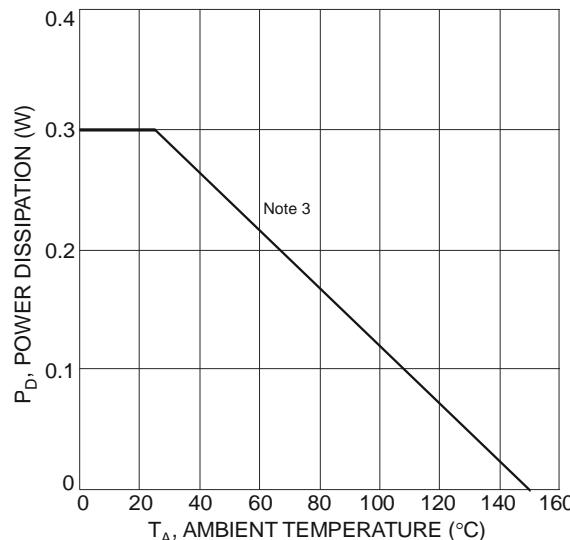


Fig. 3 Power Dissipation vs. Ambient Temperature

**Electrical Characteristics** @ $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS</b>					
Collector-Base Breakdown Voltage	$V_{(\text{BR})\text{CBO}}$	60	—	V	$I_C = 10\mu\text{A}, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 5)	$V_{(\text{BR})\text{CEO}}$	40	—	V	$I_C = 1.0\text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	$V_{(\text{BR})\text{EBO}}$	6.0	—	V	$I_E = 10\mu\text{A}, I_C = 0$
Collector Cutoff Current	$I_{\text{CEX}}$	—	50	nA	$V_{\text{CE}} = 30\text{V}, V_{\text{EB}(\text{OFF})} = 3.0\text{V}$
Base Cutoff Current	$I_{\text{BL}}$	—	50	nA	$V_{\text{CE}} = 30\text{V}, V_{\text{EB}(\text{OFF})} = 3.0\text{V}$
<b>ON CHARACTERISTICS</b> (Note 5)					
DC Current Gain	$h_{\text{FE}}$	40 70 100 60 30	— 300	—	$I_C = 100\mu\text{A}, V_{\text{CE}} = 1.0\text{V}$ $I_C = 1.0\text{mA}, V_{\text{CE}} = 1.0\text{V}$ $I_C = 10\text{mA}, V_{\text{CE}} = 1.0\text{V}$ $I_C = 50\text{mA}, V_{\text{CE}} = 1.0\text{V}$ $I_C = 100\text{mA}, V_{\text{CE}} = 1.0\text{V}$
Collector-Emitter Saturation Voltage	$V_{\text{CE}(\text{SAT})}$	—	0.20 0.30	V	$I_C = 10\text{mA}, I_B = 1.0\text{mA}$ $I_C = 50\text{mA}, I_B = 5.0\text{mA}$
Base-Emitter Saturation Voltage	$V_{\text{BE}(\text{SAT})}$	0.65	0.85 0.95	V	$I_C = 10\text{mA}, I_B = 1.0\text{mA}$ $I_C = 50\text{mA}, I_B = 5.0\text{mA}$
<b>SMALL SIGNAL CHARACTERISTICS</b>					
Output Capacitance	$C_{\text{obo}}$	—	4.0	pF	$V_{\text{CB}} = 5.0\text{V}, f = 1.0\text{MHz}, I_E = 0$
Input Capacitance	$C_{\text{ibo}}$	—	8.5	pF	$V_{\text{EB}} = 0.5\text{V}, f = 1.0\text{MHz}, I_C = 0$
Input Impedance	$h_{\text{ie}}$	1.0	10	k $\Omega$	
Voltage Feedback Ratio	$h_{\text{re}}$	0.5	8.0	$\times 10^{-4}$	
Small Signal Current Gain	$h_{\text{fe}}$	100	400	—	$V_{\text{CE}} = 10\text{V}, I_C = 1.0\text{mA}, f = 1.0\text{kHz}$
Output Admittance	$h_{\text{oe}}$	1.0	40	$\mu\text{S}$	
Current Gain-Bandwidth Product	$f_T$	300	—	MHz	$V_{\text{CE}} = 20\text{V}, I_C = 10\text{mA}, f = 100\text{MHz}$
<b>SWITCHING CHARACTERISTICS</b>					
Delay Time	$t_d$	—	35	ns	$V_{\text{CC}} = 3.0\text{V}, I_C = 10\text{mA}$
Rise Time	$t_r$	—	35	ns	$V_{\text{BE}(\text{off})} = -0.5\text{V}, I_{B1} = 1.0\text{mA}$
Storage Time	$t_s$	—	200	ns	$V_{\text{CC}} = 3.0\text{V}, I_C = 10\text{mA}$
Fall Time	$t_f$	—	50	ns	$I_{B1} = I_{B2} = 1.0\text{mA}$

Notes: 5. Short duration pulse test used to minimize self-heating effect.

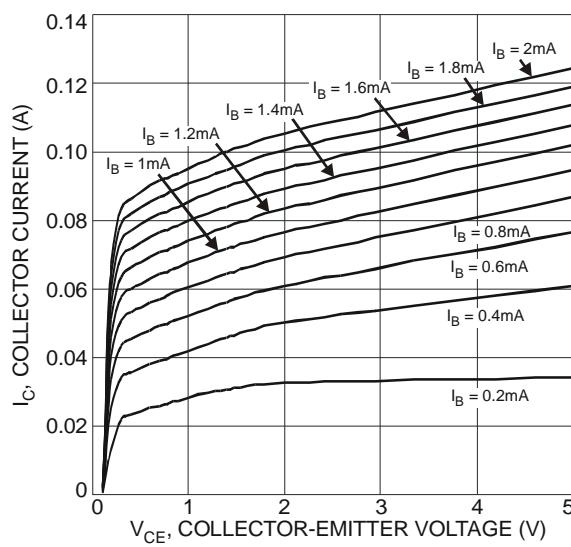


Fig. 4 Typical Collector Current vs. Collector-Emitter Voltage

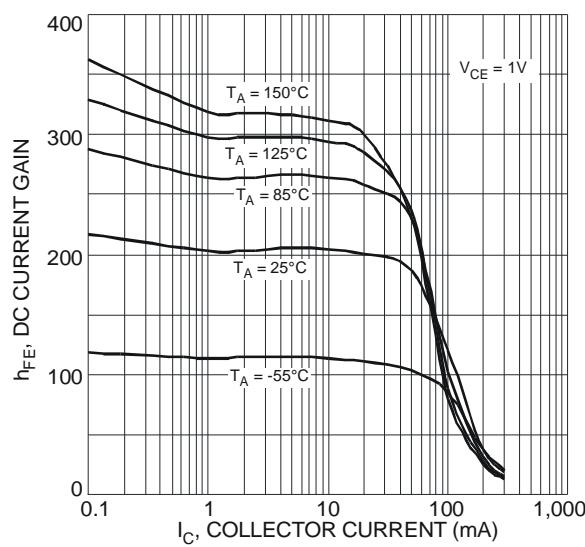


Fig. 5 Typical DC Current Gain vs. Collector Current

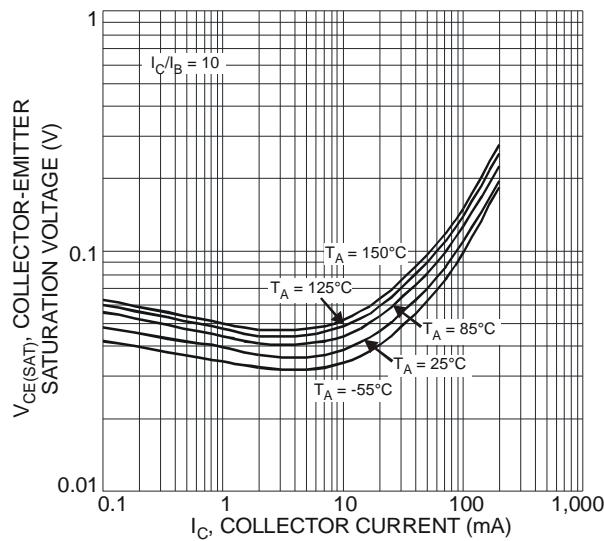


Fig. 6 Typical Collector-Emitter Saturation Voltage vs. Collector Current

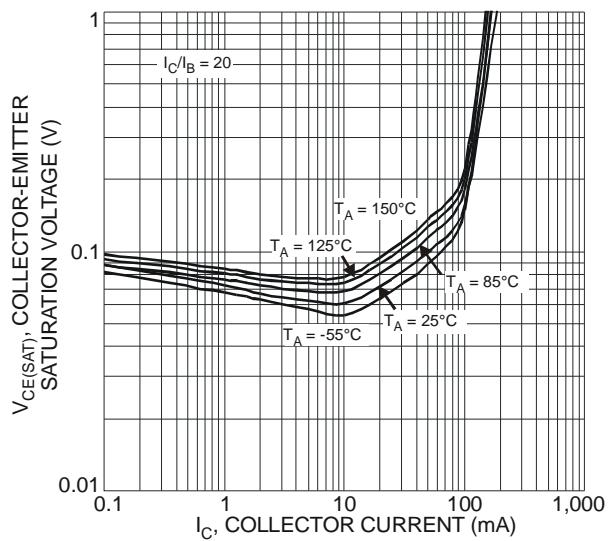


Fig. 7 Typical Collector-Emitter Saturation Voltage vs. Collector Current

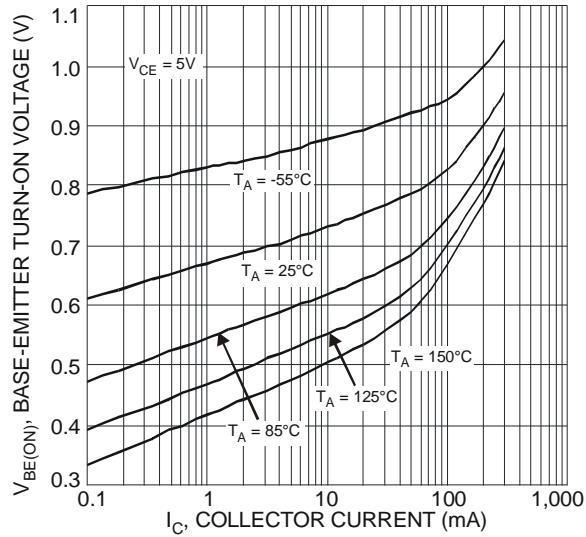


Fig. 8 Typical Base-Emitter Turn-On Voltage vs. Collector Current

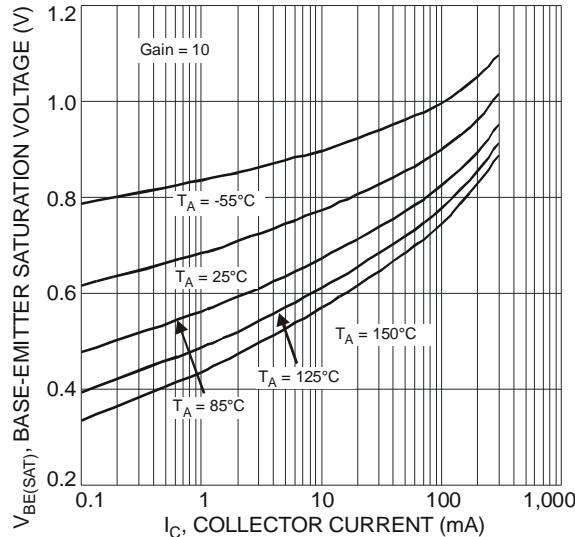
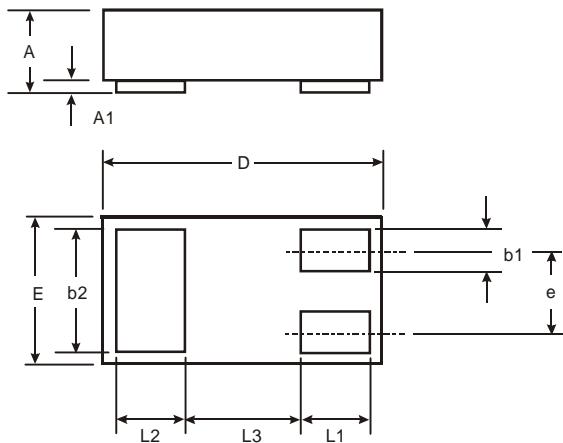


Fig. 9 Typical Base-Emitter Saturation Voltage vs. Collector Current

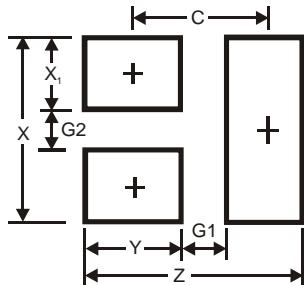
## Package Outline Dimensions



DFN1006-3			
Dim	Min	Max	Typ
<b>A</b>	0.47	0.53	0.50
<b>A1</b>	0	0.05	0.03
<b>b1</b>	0.10	0.20	0.15
<b>b2</b>	0.45	0.55	0.50
<b>D</b>	0.95	1.075	1.00
<b>E</b>	0.55	0.675	0.60
<b>e</b>	—	—	0.35
<b>L1</b>	0.20	0.30	0.25
<b>L2</b>	0.20	0.30	0.25
<b>L3</b>	—	—	0.40

All Dimensions in mm

## Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.1
G1	0.3
G2	0.2
X	0.7
X1	0.25
Y	0.4
C	0.7

### IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

### LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2010, Diodes Incorporated

[www.diodes.com](http://www.diodes.com)